

Substitute for form 1449A/PTO INFORMATION DISCLOSURE STATEMENT BY APPLICANT <i>(Use as many sheets as necessary)</i>		Complete if Known	
		Application Number	Unknown - 101730,641
		Filing Date	Even Date Herewith - 12/8/03
		First Named Inventor	Farrar, Paul
		Group Art Unit	Unknown - 2815
		Examiner Name	Owens, Beth - FENTY, JESSE
Sheet 1 of 5		Attorney Docket No: 1303.041US2	

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		First Named Inventor	Farrar, Paul			
		Group Art Unit	Unknown 2815			
		Examiner Name	Owens, Beth Fenty, J-ssse			
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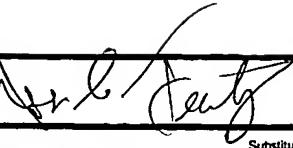
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		First Named Inventor <u>Farrar, Paul</u>
		Group Art Unit <u>Unknown</u> 2815
		Examiner Name <u>Owens, Beth</u> <u>FENTY, JESS</u>
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* EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant. 1 Applicant's unique citation designation number (optional) 2 Applicant is to place a check mark here if English language Translation is attached